US005364890A

United States Patent [19]

Sakuma et al.

[11] **Patent Number: 5,364,890**

[45] **Date of Patent: Nov. 15, 1994**

[54] **DENTAL ADHESIVE COMPOSITION**

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[21] Appl. No.: **67,174**

[22] Filed: **May 26, 1993**

Related U.S. Application Data

[63] Continuation of Ser. No. 911,512, Jul. 10, 1992, abandoned.

[30] **Foreign Application Priority Data**

Oct. 11, 1991 [JP] Japan 3-290422

[51] **Int. Cl.**[5] **A61K 6/08**

[52] **U.S. Cl.** **522/92**; 106/35; 523/118

[58] **Field of Search** 106/35; 523/109-116; 433/228.1; 564/252; 526/217, 328, 329.7; 522/92

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[57] **ABSTRACT**

A compound having a carbodiimide in its molecule is incorporated in a dental adhesive composition. With this composition, dental composite material can be firmly bonded to the enamel and dentin of a tooth, thereby avoiding formation of a gap which may otherwise cause secondary caries.

20 Claims, No Drawings